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MOSFET - Power, Single N-Channel

40 V, 1.1 mΩ**, 277 A**

NVMTS1D1N04C

Features

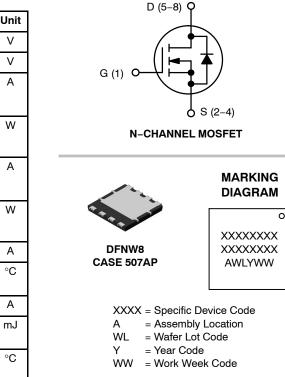
- Small Footprint (8x8 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- New Power 88 Package
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.1 m Ω @ 10 V	277 A



MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		$T_C = 25^{\circ}C$	Ι _D	277	А
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		196	
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	153	W
R _{θJC} (Note 1)		$T_C = 100^{\circ}C$		76.5	
Continuous Drain	Steady	$T_A = 25^{\circ}C$	I _D	48.8	А
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		34.5	
Power Dissipation	State	$T_A = 25^{\circ}C$	PD	4.7	W
R _{θJA} (Notes 1, 2)		$T_A = 100^{\circ}C$		2.4	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	900	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	128	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 22 A)			E _{AS}	721	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.98	°C/W
Junction-to-Ambient - Steady State (Note 2)	R _{0.IA}	31.6	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 $\rm mm^2,$ 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				21		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}					10	_
		V _{DS} = 40 V	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V				±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 210 μA	2.0	2.8	4.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-7.4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.87	1.1	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 5 V, I _D = 50 A			136		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			5410		
Output Capacitance	C _{OSS}				3145		pF
Reverse Transfer Capacitance	C _{RSS}				82		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A			86		nC
Threshold Gate Charge	Q _{G(TH)}				10		
Gate-to-Source Charge	Q _{GS}				24		
Gate-to-Drain Charge	Q _{GD}				24		
Plateau Voltage	V _{GP}				4.8		V
SWITCHING CHARACTERISTICS (Note \$	5)						
Turn–On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 20 V, I_{D} = 50 A, R_{G} = 6 Ω			23		- ns
Rise Time	tr				27		
Turn–Off Delay Time	t _{d(OFF)}				60		
Fall Time	t _f				32		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.79	1.2	
		$I_{\rm S} = 50 \rm A$	T _J = 125°C		0.65 V		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			81		
Charge Time	t _a				43		ns
Discharge Time	t _b				38		
Reverse Recovery Charge	Q _{RR}				100		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

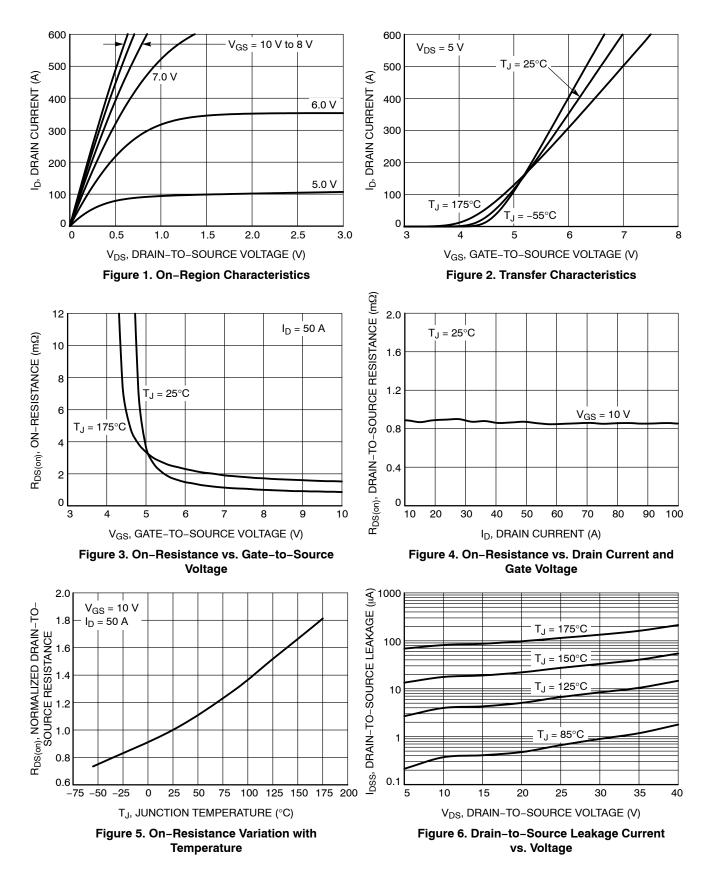
4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

DEVICE ORDERING INFORMATION

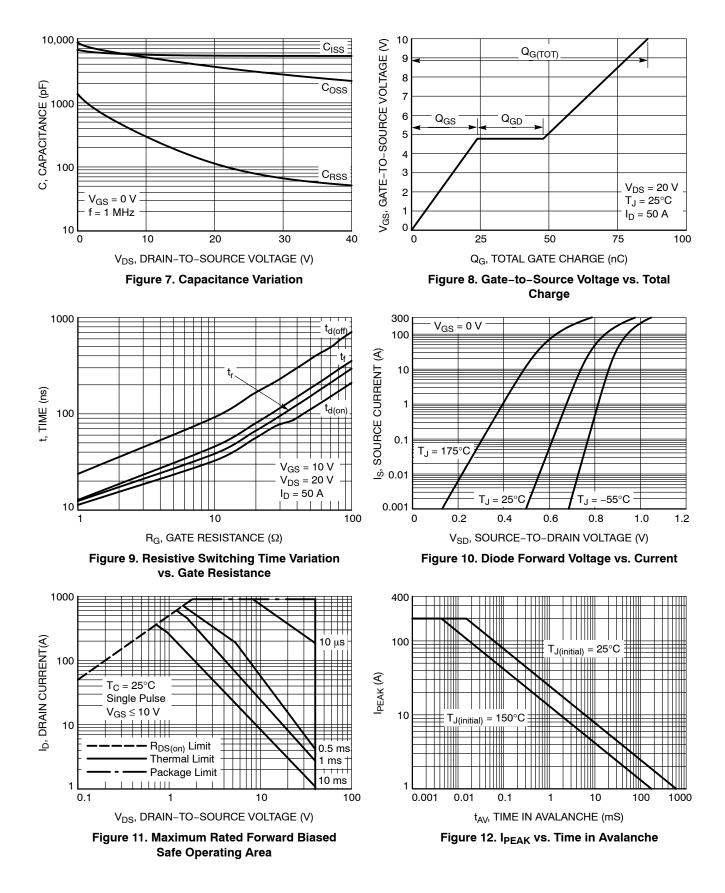
Device	Marking	Package	Shipping [†]
NVMTS1D1N04CTXG	1D1N04C	POWER 88 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

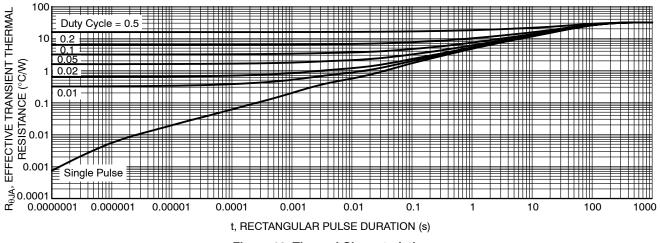
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

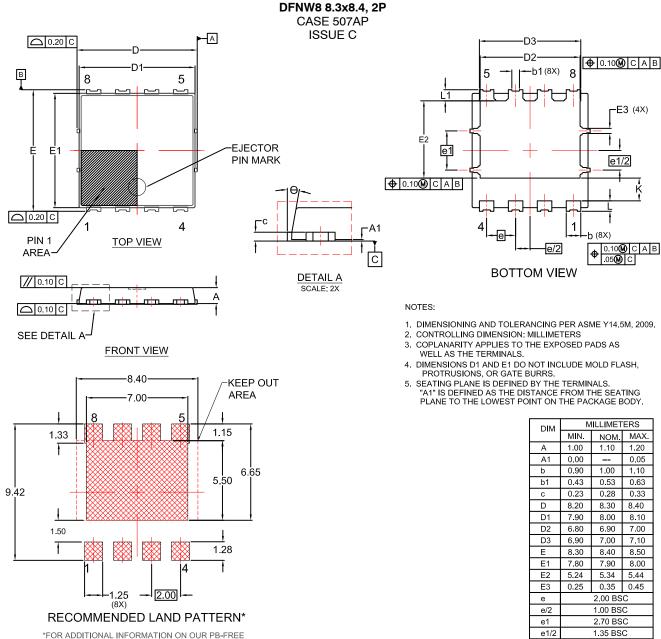


TYPICAL CHARACTERISTICS





PACKAGE DIMENSIONS



*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

1.57 1.70

0.74 0.84

0.87

12°

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Κ

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1.50

0.64

0.67

0°

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